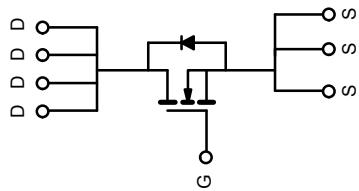
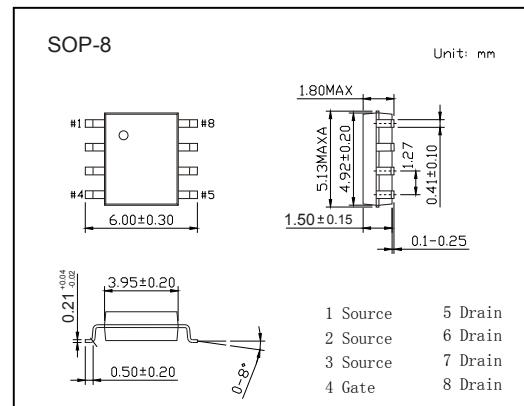


**N-Channel MOSFET****SI9410DY (KI9410DY)****■ Features**

- $V_{DS} (V) = 30V$
- $I_D = 7 A$  ( $V_{GS} = 10V$ )
- $R_{DS(ON)} < 30m\Omega$  ( $V_{GS} = 10V$ )
- $R_{DS(ON)} < 40m\Omega$  ( $V_{GS} = 5V$ )
- $R_{DS(ON)} < 50m\Omega$  ( $V_{GS} = 4.5V$ )

**■ Absolute Maximum Ratings  $T_a = 25^\circ C$** 

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	$V_{DS}$	30	V
Gate-Source Voltage	$V_{GS}$	$\pm 20$	
Continuous Drain Current (Note.1)	$I_D$	7	A
		5.8	
Pulsed Drain Current	$I_{DM}$	30	
Power Dissipation (Note.1)	$P_D$	2.5	W
		1.6	
Thermal Resistance.Junction- to-Ambient	$R_{thJA}$	50	$^\circ C/W$
Junction Temperature	$T_J$	150	$^\circ C$
Storage Temperature Range	$T_{stg}$	-55 to 150	

Note.1: Surface Mounted on FR4 Board,  $t \leq 10$  sec.

## N-Channel MOSFET

### SI9410DY (KI9410DY)

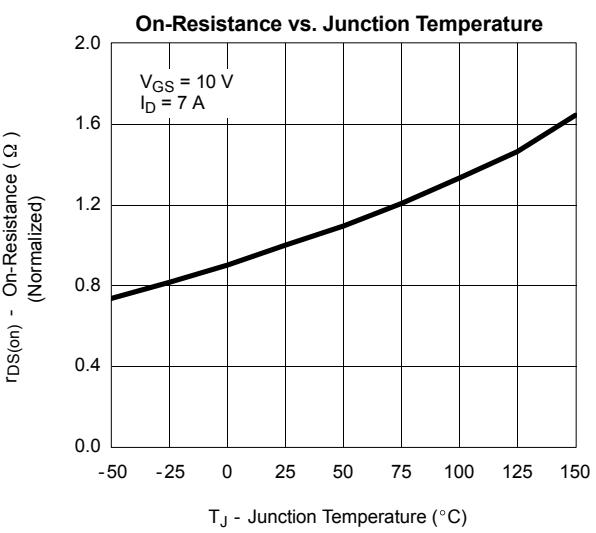
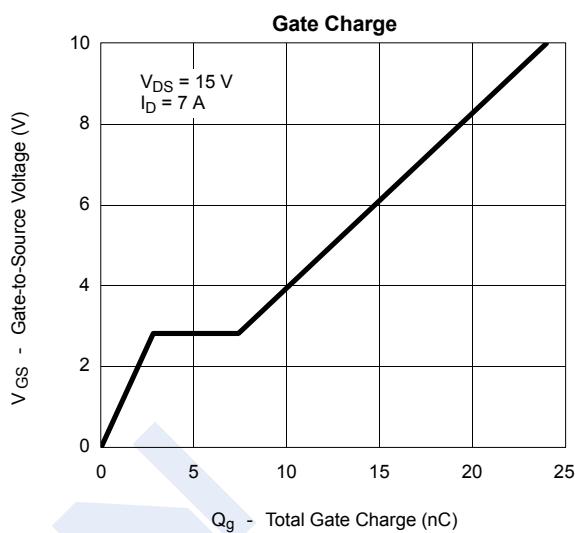
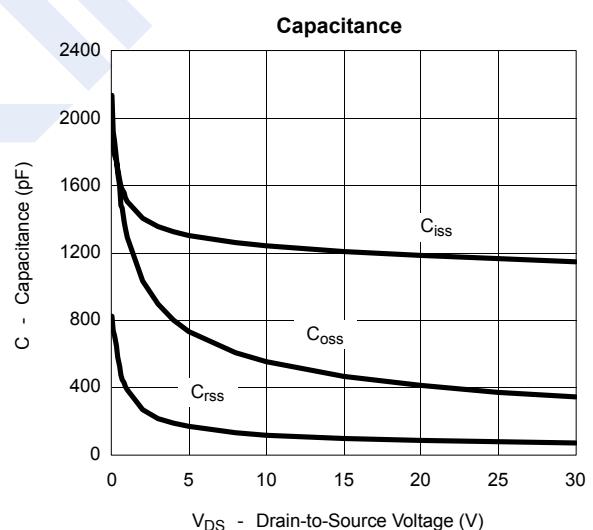
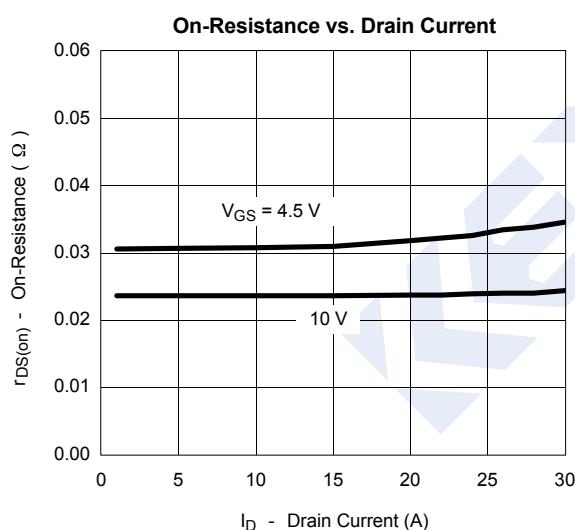
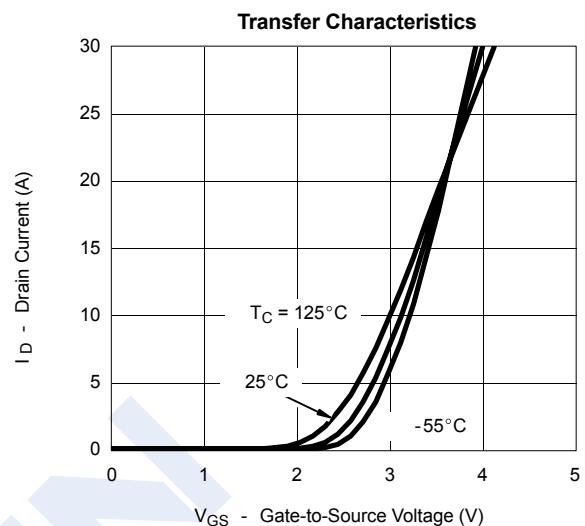
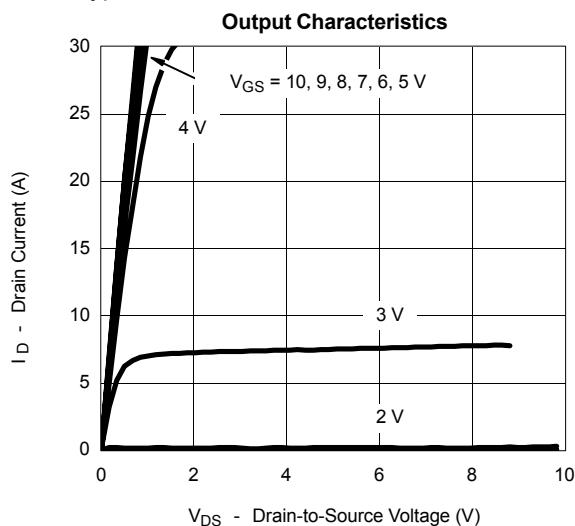
■ Electrical Characteristics Ta = 25°C

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	V <sub>DSS</sub>	I <sub>D</sub> =250 μ A, V <sub>GS</sub> =0V	30			V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>Ds</sub> =24V, V <sub>GS</sub> =0V			2	μ A
		V <sub>Ds</sub> =24V, V <sub>GS</sub> =0V, T <sub>J</sub> =55°C			25	
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>Ds</sub> =0V, V <sub>GS</sub> =±20V			± 100	nA
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>Ds</sub> =V <sub>GS</sub> , I <sub>D</sub> =250 μ A	1		3	V
Static Drain-Source On-Resistance	R <sub>Ds(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =7A (Note.1)			30	mΩ
		V <sub>GS</sub> =5V, I <sub>D</sub> =4A (Note.1)			40	
		V <sub>GS</sub> =4.5V, I <sub>D</sub> =3.5A (Note.1)			50	
On-State Drain Current	I <sub>D(on)</sub>	V <sub>Ds</sub> ≥5 V, V <sub>GS</sub> = 10 V	30			A
Forward Transconductance	g <sub>FS</sub>	V <sub>Ds</sub> =15V, I <sub>D</sub> =7A (Note.1)		15		S
Total Gate Charge	Q <sub>G</sub>	V <sub>GS</sub> =10V, V <sub>Ds</sub> =15V, I <sub>D</sub> =7A		24	50	nC
Gate Source Charge	Q <sub>GS</sub>			2.8		
Gate Drain Charge	Q <sub>Gd</sub>			4.6		
Turn-On Delay Time	t <sub>d(on)</sub>	V <sub>GS</sub> =10V, V <sub>Ds</sub> =25V, R <sub>L</sub> =25 Ω , R <sub>GEN</sub> =6 Ω I <sub>D</sub> =1A		14	30	ns
Turn-On Rise Time	t <sub>r</sub>			10	60	
Turn-Off Delay Time	t <sub>d(off)</sub>			46	150	
Turn-Off Fall Time	t <sub>f</sub>			17	140	
Body Diode Reverse Recovery Time	t <sub>rr</sub>	I <sub>F</sub> = 2A, dI/dt= 100A/ μ s		60		
Maximum Body-Diode Continuous Current	I <sub>S</sub>				2.8	A
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =2A, V <sub>GS</sub> =0V (Note.1)			1.1	V

Note.1:Pulse test; pulse width ≤ 300us, duty cycle ≤ 2%.

#### ■ Marking

Marking	9410 KC****
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**N-Channel MOSFET****SI9410DY (KI9410DY)****■ Typical Characteristics**

## N-Channel MOSFET

## SI9410DY (KI9410DY)

## ■ Typical Characteristics

